

SEMITOP[®] 2

IGBT Module

SK 8 GD 126

Target Data

Features

- Fast Trench IGBTs
- Soft freewheeling diodes in
- CAL High Density technology · Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)

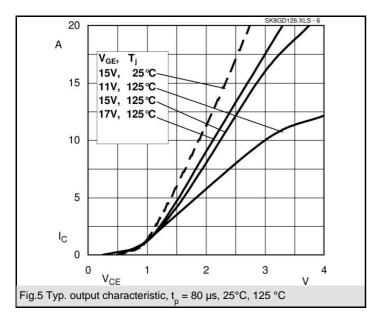
Typical Applications

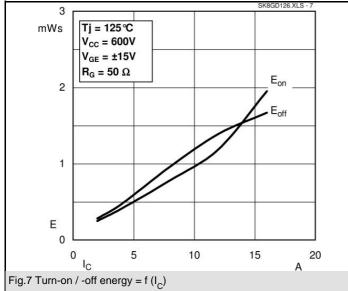
- Switching (not for linear use)
- Inverter .
- Switched mode power supplies
- UPS

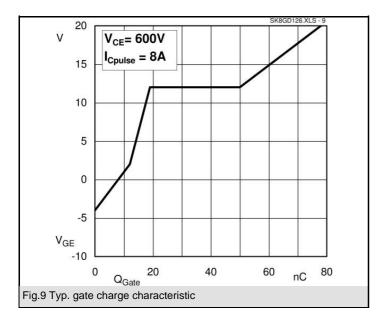
Absolute Maximum Ratings $T_s = 25 \text{ °C}$, unless otherwise specified							
Symbol	Conditions		Values				
IGBT							
V _{CES}			1200		V		
V _{GES}			± 20		V		
I _C	T _s = 25 (80) °C;		15 (10)				
I _{CM}	t _p < 1 ms; T _s = 25 (80) °C;		30 (20)				
T _j			- 40 + 150		°C		
Inverse/F	reewheeling CAL diode						
I _F	T _s = 25 (80) °C;		13 (9)				
$I_{FM} = -I_{CM}$	t _p < 1 ms; T _s = 25 (80) °C;		26 (18)				
T _j			- 40 + 150		°C		
T _{stg}			- 40 + 125		°C		
T _{sol}	Terminals, 10 s		260				
V _{isol}	AC 50 Hz, r.m.s. 1 min. / 1 s		2500 / 3000 V				
	·						
Characte	ristics	T _s = 25 °C	$T_s = 25 \text{ °C}$, unless otherwise specified				
Symbol	Conditions	min.	typ.	max.	Units		
IGBT							
V _{CE(sat)}	I _C = 8 A, T _i = 25 (125) °C		1,7 (2)	2,1	V		
V _{GE(th)}	$V_{CE} = V_{GE}$; I _C = 0,0003 A	5	5,8	6,5	V		
Cies	$V_{CE} = 25 V; V_{GE} = 0 V; 1 MHz$		0,7		nF		
R _{th(j-s)}	per IGBT			2	K/W		
/							

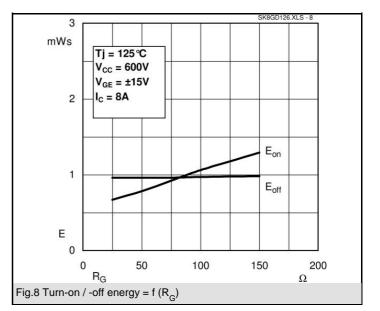
Cies	$v_{CE} = 23 v, v_{GE} = 0 v, 1 W \square Z$	0,7		nF
R _{th(j-s)}	per IGBT		2	K/W
G ,	per module			K/W
	under following conditions:			
t _{d(on)}	$V_{CC} = 600 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$	85		ns
t,	I _C = 8 A, T _i = 125 °C	30		ns
t _{d(off)}	$R_{Gon} = R_{Goff} = 50 \Omega$	430		ns
t _f		90		ns
$E_{on} + E_{off}$	Inductive load	1,9		mJ
Inverse/	Freewheeling CAL diode			
$V_F = V_{EC}$	I _F = 8 A; T _i = 25 (125) °C	1,9 (2)	2 (2,4)	V
V _(TO)	$T_{i} = (125)^{\circ}C$	1 (0,8)	1,1	V
r _T	T _j = (125) °C	112 (150)	138	mΩ
R _{th(j-s)}			2,8	K/W
	under following conditions:			
I _{RRM}	I _F = 8 A; V _R = 600 V	9,4		А
Q _{rr}	dI _F /dt = 300 A/µs	1,5		μC
E _{off}	V _{GE} = 0 V; T _j = 125 °C	0,6		mJ
Mechani	cal data			•
M1	mounting torque		2	Nm
w		21		g
Case	SEMITOP [®] 2	T 47		

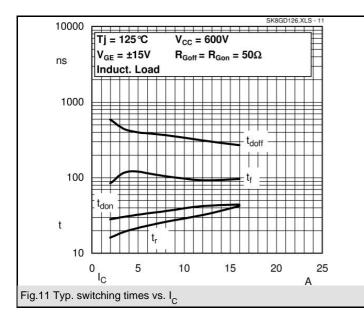
GD

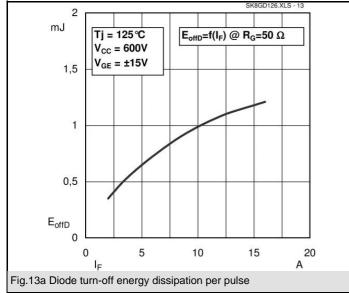


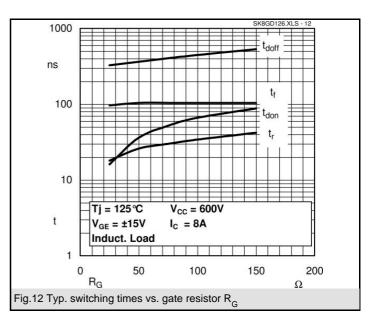


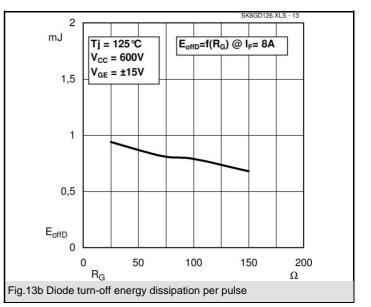


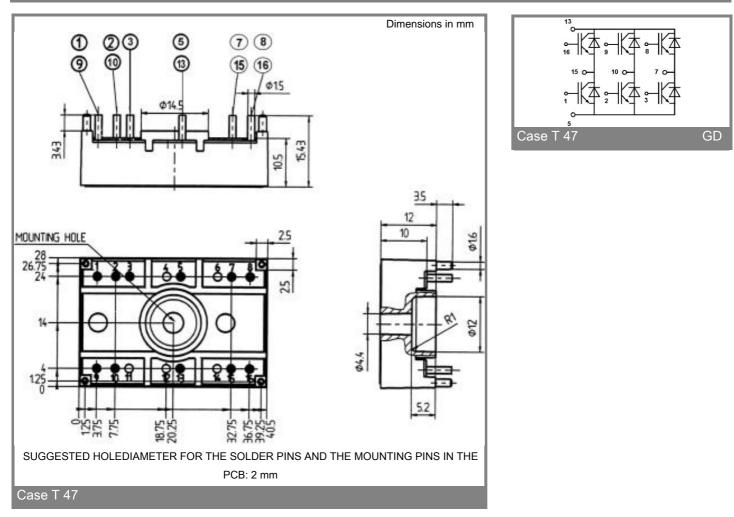












This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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